

## MOC8030, MOC8050



### DESCRIPTION

The MOC8030 and MOC8050 series optocoupler consists of an infrared emitting diode optically coupled to an NPN silicon photodarlington with the base pin unconnected in a standard 6 pin dual in line plastic package.

### FEATURES

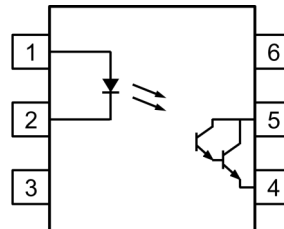
- High AC Isolation Voltage 5000V<sub>RMS</sub>
- Wide Operating Temperature Range
- -25°C to 100°C
- Base pin unconnected for improved Noise Immunity in high EMI environment
- RoHS Compliant
- UL Approval E91231 Model "SS"
- VDE Approval 40028086

### APPLICATIONS

- Computer Terminals
- Industrial System Controllers
- Measurement Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

### ORDER INFORMATION

- Add Suffix "X" for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel



- 1 Anode
- 2 Cathode
- 3 NC
- 4 Emitter
- 5 Collector
- 6 NC

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

#### Input

Forward Current	50mA
Reverse Voltage	6V
Power Dissipation	70mW

#### Output

Collector Current	80mA
Collector to Emitter Voltage V <sub>CEO</sub>	80V
Emitter to Collector Voltage V <sub>ECO</sub>	6V
Power Dissipation	150mW

#### Total Package

Total Power Dissipation	170mW
Isolation Voltage	5000V <sub>RMS</sub>
Operating Temperature	-40 to 100°C
Storage Temperature	-40 to 125°C
Junction Temperature	125°C
Lead Soldering Temperature (10s)	260°C

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### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

#### INPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward Voltage	$V_F$	$I_F = 10\text{mA}$		1.2	1.4	V
Reverse Current	$I_R$	$V_R = 4\text{V}$			10	$\mu\text{A}$
Terminal Capacitance	$C_t$	$V_F = 0\text{V}, f = 1\text{MHz}$		30	250	pF

#### OUTPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector-Emitter Breakdown Voltage	$BV_{CEO}$	$I_C = 1\text{mA}, I_F = 0\text{mA}$	80			V
Emitter-Collector Breakdown Voltage	$BV_{ECO}$	$I_E = 10\mu\text{A}, I_F = 0\text{mA}$	6			V
Collector Dark Current	$I_{CEO}$	$V_{CE} = 10\text{V}, I_F = 0\text{mA}$			1000	nA

#### COUPLED

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	CTR	$I_F = 10\text{mA}, V_{CE} = 1.5\text{V}$ MOC8030 MOC8050	300 500			%
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F = 20\text{mA}, I_C = 5\text{mA}$			1.0	V
Floating Capacitance	$C_f$	$V_{IO} = 0\text{V}, f = 1\text{MHz}$		0.6	1	pF
Cut-Off Frequency	$f_c$	$V_{CE} = 2\text{V}, I_C = 20\text{mA}$ $R_L = 100\Omega, -3\text{dB}$		6		kHz
Output Rise Time	$t_r$	$V_{CE} = 2\text{V}, I_C = 10\text{mA}$ $R_L = 100\Omega$		60	250	$\mu\text{s}$
Output Fall Time	$t_f$			53	250	$\mu\text{s}$

## MOC8030, MOC8050

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

#### ISOLATION

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Isolation Voltage	$V_{\text{ISO}}$	R.H. = 40% to 60%, $t = 1$ min Note 1	5000			$V_{\text{RMS}}$
Isolation Resistance	$R_{\text{ISO}}$	$V_{\text{I-O}} = 500\text{VDC}$ R.H. = 40% to 60% Note 1	$5 \times 10^{10}$	$1 \times 10^{11}$		$\Omega$

Note 1 : Measured with input leads shorted together and output leads shorted together.

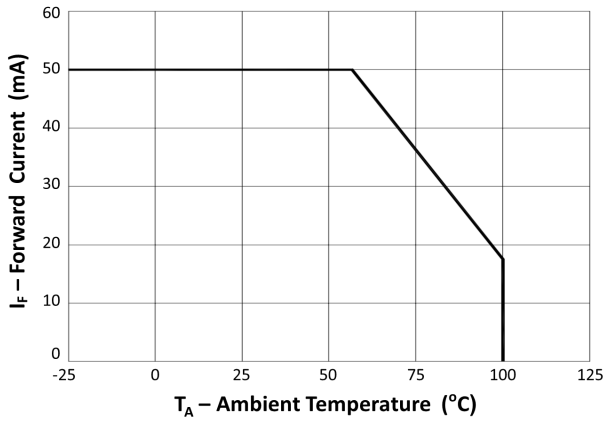


Fig 1 Forward Current vs Ambient Temperature

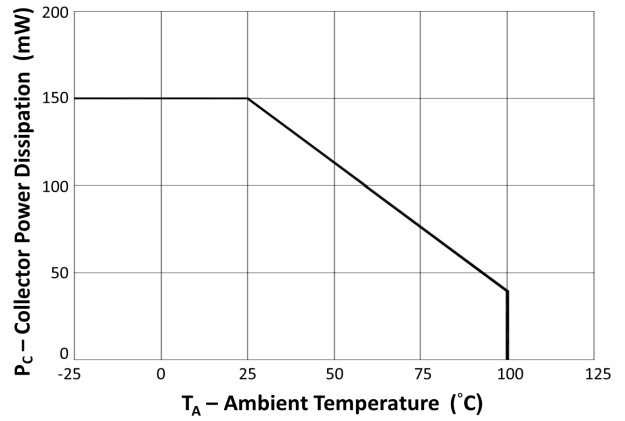


Fig 2 Collector Power Dissipation vs Ambient Temperature

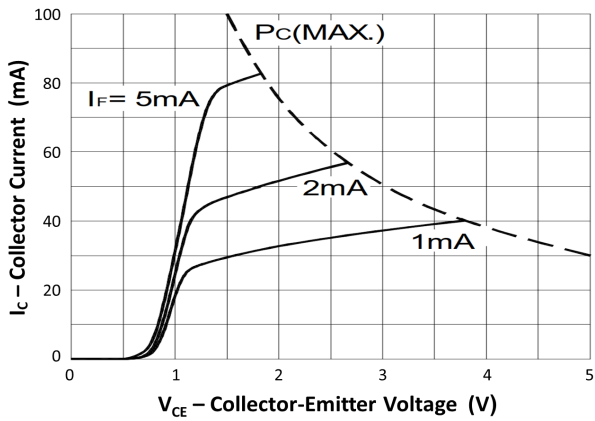


Fig 3 Collector Current vs Collector-Emitter Voltage (1)

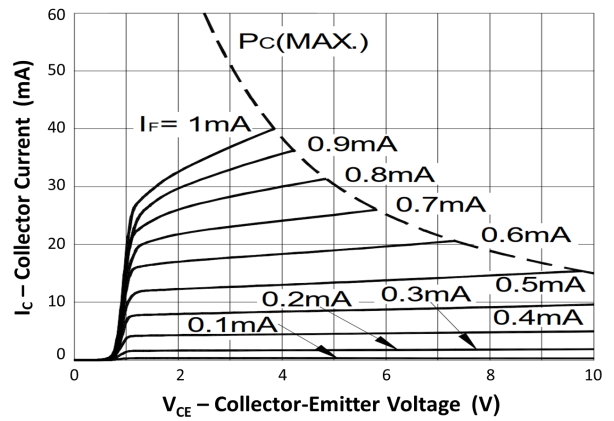


Fig 4 Collector Current vs Collector-Emitter Voltage (2)

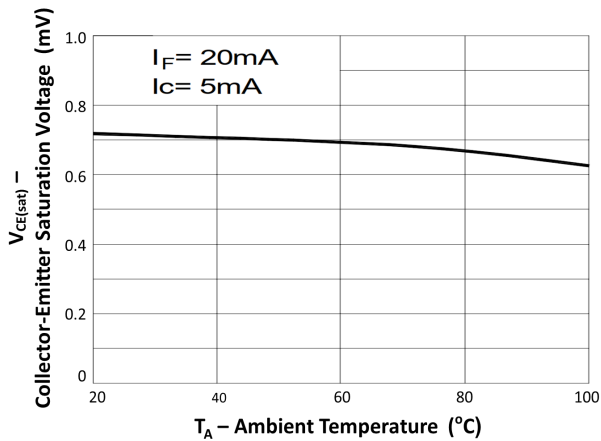


Fig 5 Collector-Emitter Saturation Voltage vs Ambient Temperature

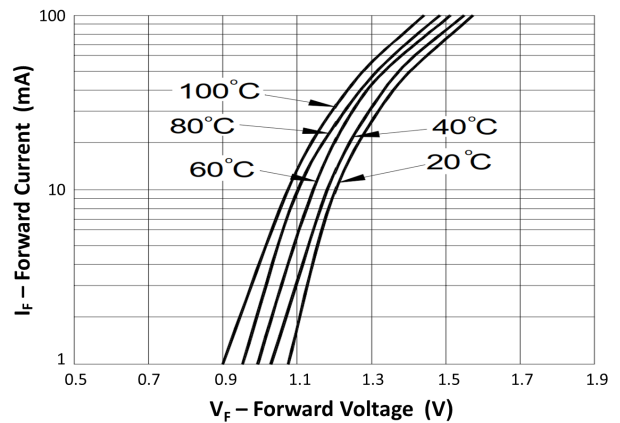


Fig 6 Forward Current vs Forward Voltage

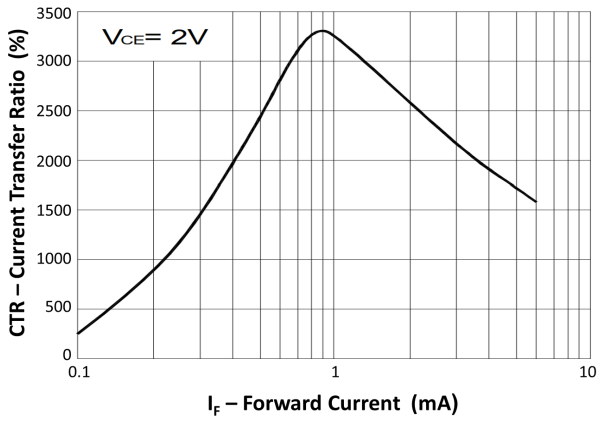


Fig 7 Current Transfer Ratio vs Forward Current

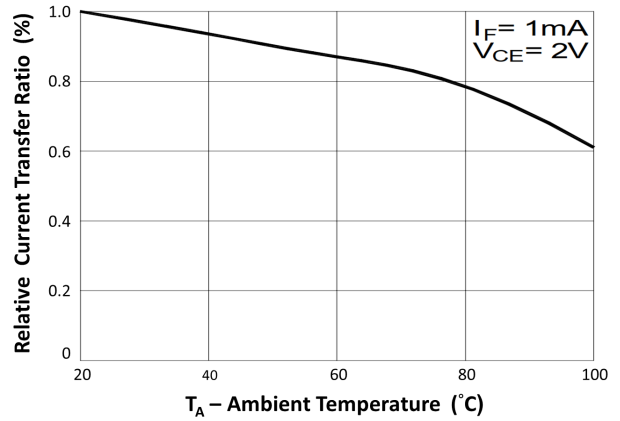


Fig 8 Relative Current Transfer Ratio vs Ambient Temperature

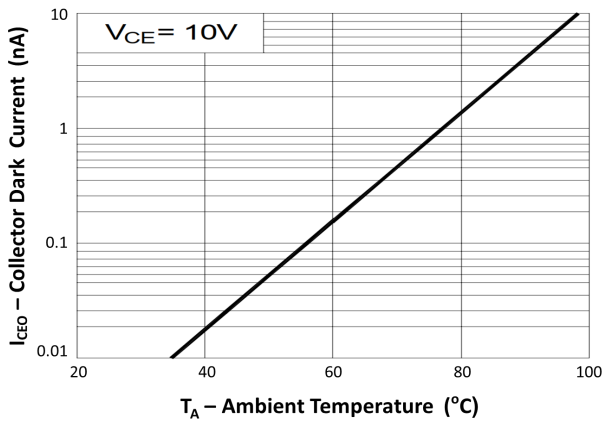


Fig 9 Collector Dark Current vs Ambient Temperature

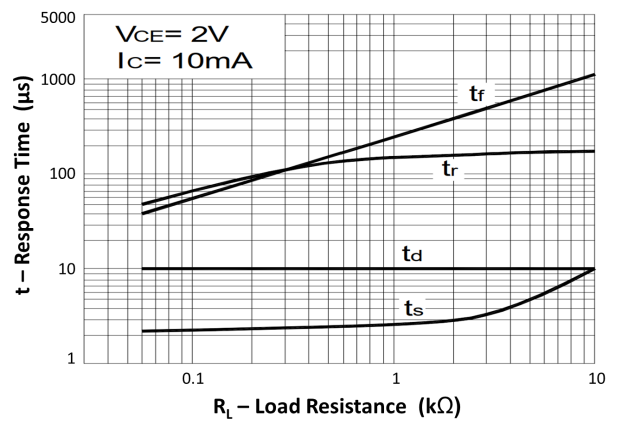


Fig 10 Response Time vs Load Resistance

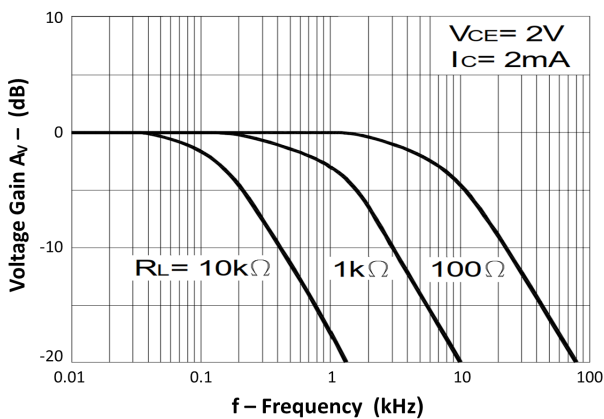
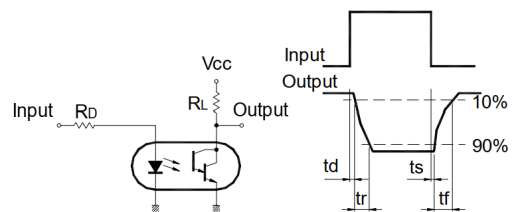
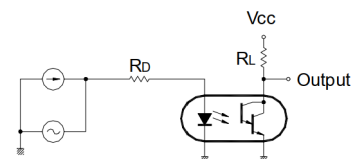


Fig 11 Frequency Response



Response Time Test Circuit



Frequency Response Test Circuit

## MOC8030, MOC8050

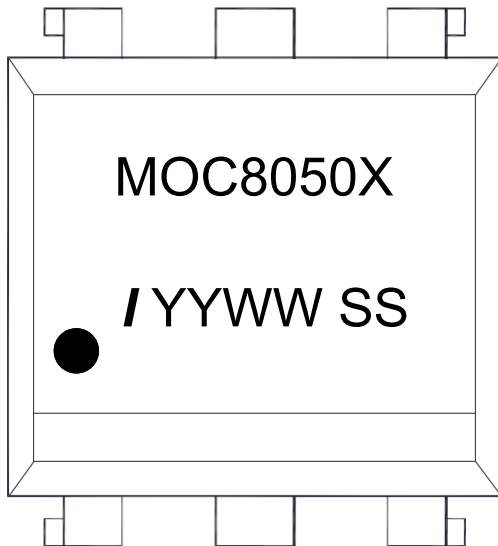
### ORDER INFORMATION

MOC8030, MOC8050 (UL Approval)			
After PN	PN	Description	Packing quantity
None	MOC8030, MOC8050	Standard DIP6	65 pcs per tube
G	MOC8030G, MOC8050G	10mm Lead Spacing	65 pcs per tube
SM	MOC8030SM, MOC8050SM	Surface Mount	65 pcs per tube
SMT&R	MOC8030SMT&R MOC8050SMT&R	Surface Mount Tape and Reel	1000 pcs per reel

MOC8030X, MOC8050X (UL and VDE Approvals)			
After PN	PN	Description	Packing quantity
None	MOC8030X, MOC8050X	Standard DIP6	65 pcs per tube
G	MOC8030XG, MOC8050XG	10mm Lead Spacing	65 pcs per tube
SM	MOC8030XSM, MOC8050XSM	Surface Mount	65 pcs per tube
SMT&R	MOC8030XSMT&R MOC8050XSMT&R	Surface Mount Tape and Reel	1000 pcs per reel

**DEVICE MARKING**

**Example : MOC8050X**

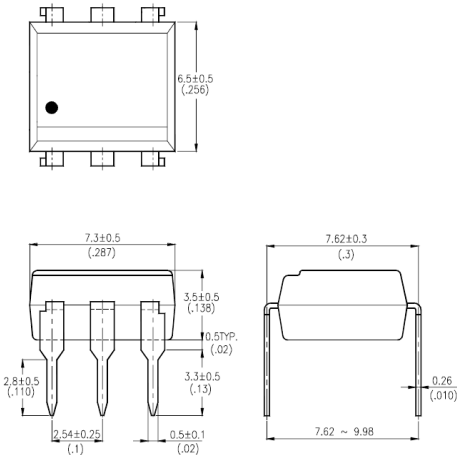


MOC8050X	Device Part Number
/	Isocom
YY	2 digit Year code
WW	2 digit Week code
SS	UL Model

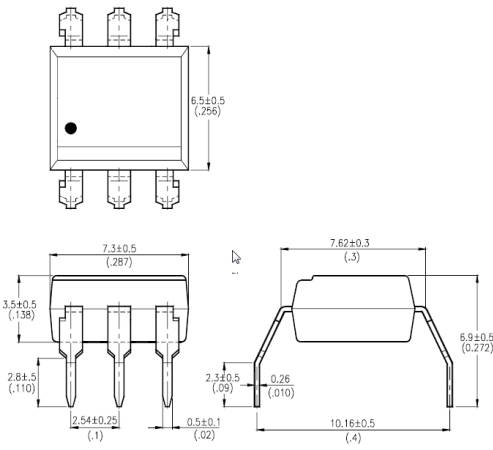
# MOC8030, MOC8050

## PACKAGE DIMENSIONS in mm (inch)

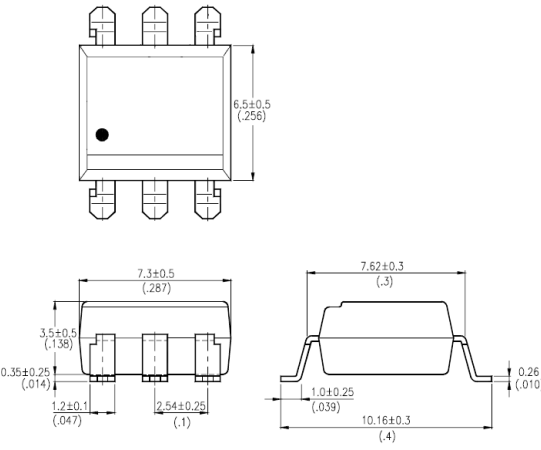
### DIP



### G Form



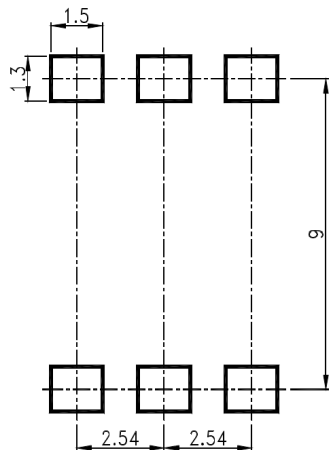
### Surface Mount



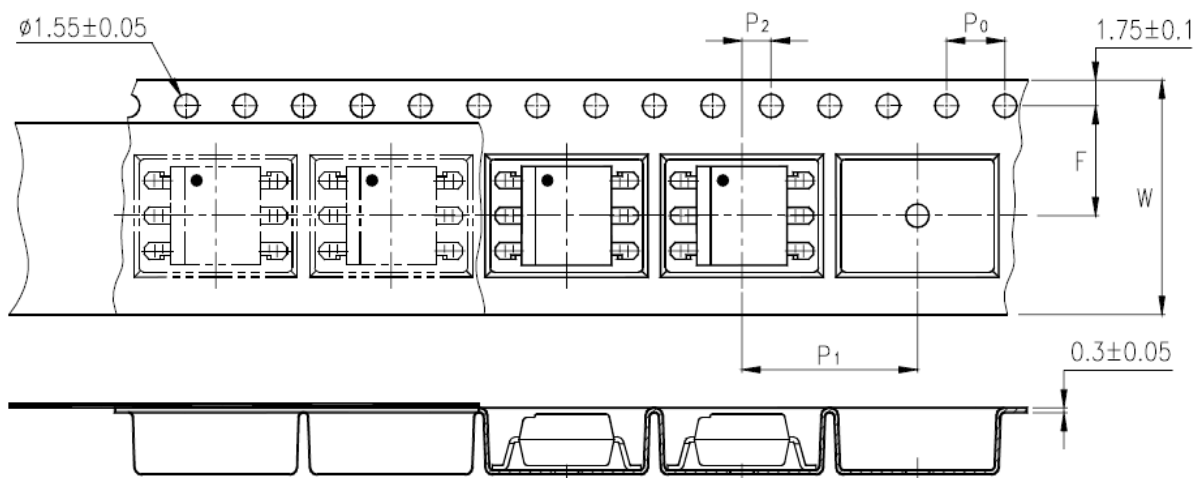




**RECOMMENDED SOLDER PAD LAYOUT (mm)**



**TAPE AND REEL PACKAGING**

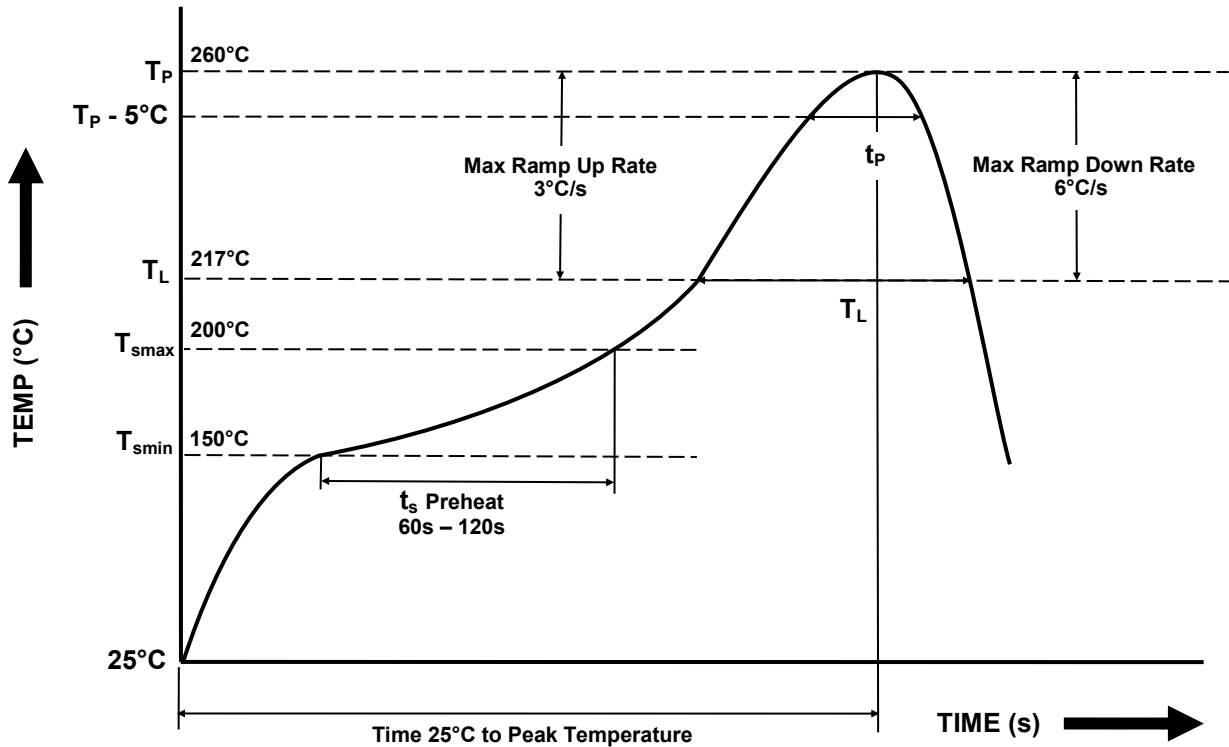


Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P <sub>0</sub>	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.295)
	P <sub>2</sub>	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P <sub>1</sub>	12 ± 0.1 (0.472)



**IR REFLOW SOLDERING TEMPERATURE PROFILE**

One Time Reflow Soldering is Recommended.  
Do not immerse device body in solder paste.



Profile Details	Conditions
<b>Preheat</b> - Min Temperature ( $T_{SMIN}$ ) - Max Temperature ( $T_{SMAX}$ ) - Time $T_{SMIN}$ to $T_{SMAX}$ ( $t_s$ )	150°C 200°C 60s - 120s
<b>Soldering Zone</b> - Peak Temperature ( $T_P$ ) - Time at Peak Temperature - Liquidous Temperature ( $T_L$ ) - Time within 5°C of Actual Peak Temperature ( $T_P - 5^\circ\text{C}$ ) - Time maintained above $T_L$ ( $t_L$ ) - Ramp Up Rate ( $T_L$ to $T_P$ ) - Ramp Down Rate ( $T_P$ to $T_L$ )	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate ( $T_{smax}$ to $T_P$ )	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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